

## KISHORE D B - SELECTED RESEARCH AND TECHNICAL WORKS (10 ITEMS)

### **1. Aegis: AI Driven Innovation and Simulation Framework**

**Year:** 2020 - Present

**Type:** Applied Research Project

**Summary:** Developed a modular AI framework that integrates simulation data, explainable ML models, and HPC workflows for computational experimentation.

**Relevance:** Demonstrates ability to design scalable systems combining **AI and computational engineering principles.**

### **2. AI Enhanced Inverse Modeling Framework (Manuscript in Preparation)**

**Year:** 2025 (Target journal submission)

**Type:** Research Manuscript (presubmission)

**Summary:** Presents an explainable AI based method for parameter inversion in physics based simulations, improving model interpretability.

**Relevance:** Core contribution toward **scientific computing and model transparency.**

### **3. CredScore: Explainable AI for Financial Trust Modeling**

**Year:** 2022

**Type:** Applied AI Prototype (Hackathon Winner)

**Summary:** Built an interpretable credit scoring engine using SHAP and LIME. Focused on feature transparency and explainable outcomes.

**Relevance:** Illustrates **model explainability and ethical AI** application principles extendable to educational and scientific domains.

### **4. Finatra Technical Disclosure #SEC-2023-41 - Automated Vulnerability Triaging**

**Year:** 2023

**Type:** Patent Disclosure

**Summary:** Introduced AI based automation for vulnerability classification and prioritization in large scale computational systems.

**Relevance:** Demonstrates expertise in **scalable AI architectures and computational workflow optimization.**

### **5. AI-Driven Fraud Detection Engine**

**Year:** 2021–2023

**Type:** Applied Computational AI

**Summary:** Designed multi-model fraud detection using anomaly detection and deep NLP; used explainable visualization to analyze model behavior.

**Relevance:** Highlights **multi-agent modeling and hybrid computational design** applicable to scientific simulation contexts.

### **6. Global Engineering Summit Talk: DevSecOps Culture for AI and Computational Engineering**

**Year:** 2022

**Type:** Invited Technical Talk

**Summary:** Presented on integrating AI observability, computational governance, and explainability in global-scale engineering.

**Relevance:** Demonstrates **thought leadership and communication of scientific computing concepts.**

### **7. Finatra Innovation Forum Presentation - Explainable AI for Simulation**

**Year:** 2023

**Type:** Invited Presentation

**Summary:** Showcased explainable AI models for understanding computational simulations and decision-making frameworks.

**Relevance:** Directly relevant to **computational visualization and scientific communication**.

#### ***8. Cloud HPC Workflow Simulator***

**Year:** 2023–Present

**Type:** Technical Prototype

**Summary:** Developed an AI-assisted orchestration tool for automating computational experiments using Python and Azure HPC.

**Relevance:** Demonstrates **hands on experience in scientific computing, parallelization, and reproducibility**.

#### ***9. Explainable AI and Scientific Visualization Curriculum***

**Year:** 2020–2023

**Type:** Educational Design Project

**Summary:** Designed interdisciplinary learning materials connecting explainable AI, simulation, and computational thinking for engineering learners.

**Relevance:** Connects **computational pedagogy and scientific visualization** aligned with UEF's research goals in educational technology.

#### ***10. Learning Analytics for Computational Thinking***

**Year:** 2024

**Type:** Educational Research Framework

**Summary:** Developed a prototype for analyzing student reasoning in simulation tasks using learning analytics and feedback-based AI models.

**Relevance:** Merges **educational data mining and computational modeling**, supporting the Educational Technology theme.

#### **Statement:**

This curated list highlights my **cross-domain contributions** at the intersection of **AI, scientific computing, and learning analytics**, reflecting both technical depth and educational application.